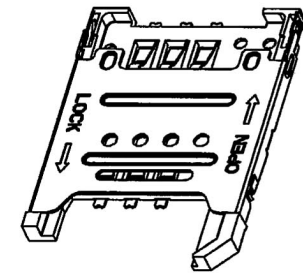


RECOMMENDED P.C.B LAYOUT  
COMPONENT SIDE(TOLERANCE ±0.05)

**TECHNICAL CHARACTERISTICS**

- 1.General Characteristics  
Dimensions: 24.65LX17.10WX1.85H mm  
Weight: Approx0.90±0.2g  
Durability:5,000 cycles min.
- 2.Electrical Characteristics  
Contact resistance:50mΩ typical,100mΩ max  
Insulation resistance:>1000MΩ/500V DC
- 3.Solderability  
IR reflow: 260°C,10sec.Max  
Manual soldering: 370°C,3sec.Max
- 4.Environmental Characteristics  
Operating temperature: -40°C~+85°C  
Operating humidity:10%~+95%RH



RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例 參考	TOLERANCE UNLESS OTHERWISE SPECIFIED	
DWG. 製圖 Betty		.X±0.25 X"±2"	
DATE 制表日 2017/01/03	UNIT 單位 M M	.XX±0.15 .X"±1"	
	PAGE 張數 1 OF 1	.XXX±0.10 .XX"±	
		SIZE. 紙張尺寸 A 4	
		REV. 版次 B	
		PART NAME 品名 SIM CARD HINGED TYPE 6P INSULATOR HEIGHT:1.85mm SELECTIVE GOLD PALTING BLACK COLOR REEL PACKING ROHS	
		PART NO. 料號 C0635-06DASBR0R	